



Not for new design, this product will be obsoleted soon

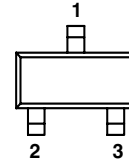
S852T / S852TW

Vishay Semiconductors

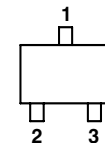
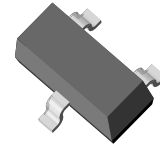
Silicon NPN Planar RF Transistor

Features

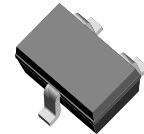
- Low supply voltage
- Low current consumption
- 50 Ω input impedance at 945 MHz
- Low noise figure
- High power gain
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



SOT-23



SOT-323



19239



Electrostatic sensitive device. Observe precautions for handling.

Applications

For low noise and high gain broadband amplifiers at collector currents from 0.2 mA to 5 mA.

Mechanical Data

Typ: S852T

Case: SOT-23 Plastic case

Weight: approx. 8.0 mg

Pinning: 1 = Collector, 2 = Base, 3 = Emitter

Typ: S852TW

Case: SOT-323 Plastic case

Weight: approx. 6.0 mg

Pinning: 1 = Collector, 2 = Base, 3 = Emitter

Parts Table

Part	Marking	Package
S852T	852	SOT-23
S852TW	W52	SOT-323

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Collector-base voltage		V _{CBO}	12	V
Collector-emitter voltage		V _{CEO}	6	V
Emitter-base voltage		V _{EBO}	2	V
Collector current		I _C	8	mA
Total power dissipation	T _{amb} ≤ 125 °C	P _{tot}	30	mW
Junction temperature		T _j	150	°C
Storage temperature range		T _{stg}	- 65 to + 150	°C

S852T / S852TW



Vishay Semiconductors

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Junction ambient	1)	R_{thJA}	450	K/W

1) on glass fibre printed board (25 x 20 x 1.5) mm³ plated with 35 μm Cu

Electrical DC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Collector-emitter cut-off current	$V_{CE} = 12\text{ V}$, $V_{BE} = 0$	I_{CES}			100	μA
Collector-base cut-off current	$V_{CB} = 8\text{ V}$, $I_E = 0$	I_{CBO}			100	nA
Emitter-base cut-off current	$V_{EB} = 1\text{ V}$, $I_C = 0$	I_{EBO}			1	μA
Collector-emitter breakdown voltage	$I_C = 1\text{ mA}$, $I_B = 0$	$V_{(BR)CEO}$	6			V
Collector-emitter saturation voltage	$I_C = 5\text{ mA}$, $I_B = 0.5\text{ mA}$	V_{CEsat}		0.1	0.4	V
DC forward current transfer ratio	$V_{CE} = 3\text{ V}$, $I_C = 1\text{ mA}$	h_{FE}	40	90	150	

Electrical AC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Transition frequency	$V_{CE} = 3\text{ V}$, $I_C = 1\text{ mA}$, $f = 500\text{ MHz}$	f_T		4.7		GHz
	$V_{CE} = 2\text{ V}$, $I_C = 1.5\text{ mA}$, $f = 500\text{ MHz}$	f_T		5.2		GHz
Collector-base capacitance	$V_{CB} = 1\text{ V}$, $f = 1\text{ MHz}$	C_{cb}		0.25		pF
Noise figure	$Z_S = Z_{Sopt}$, $f = 450\text{ MHz}$, $V_{CE} = 2\text{ V}$, $I_C = 0.5\text{ mA}$	F_{opt}		1.1		dB
	$Z_S = Z_{Sopt}$, $f = 945\text{ MHz}$, $V_{CE} = 3\text{ V}$, $I_C = 1\text{ mA}$	F_{opt}		1.8		dB
	$Z_S = Z_{Sopt}$, $f = 945\text{ MHz}$, $V_{CE} = 2\text{ V}$, $I_C = 1.5\text{ mA}$	F_{opt}		2		dB
Power gain	$V_{CE} = 2\text{ V}$, $I_C = 0.5\text{ mA}$, $f = 450\text{ MHz}$	$G_{pe} @ F_{opt}$		11.5		dB
	$V_{CE} = 3\text{ V}$, $I_C = 1\text{ mA}$, $f = 945\text{ MHz}$	$G_{pe} @ F_{opt}$		10.5		dB
	$V_{CE} = 2\text{ V}$, $I_C = 1.5\text{ mA}$, $f = 945\text{ MHz}$	$G_{pe} @ F_{opt}$		12		dB
Collector current for f_T max	$V_{CE} = 2\text{ V}$, $f = 500\text{ MHz}$	I_C		3		mA
Real part of input impedance	$V_{CE} = 3\text{ V}$, $I_C = 1\text{ mA}$, $f = 945\text{ MHz}$	$Re_{(h11e)}$		50		Ω
	$V_{CE} = 2\text{ V}$, $I_C = 1.5\text{ mA}$, $f = 945\text{ MHz}$	$Re_{(h11e)}$		50		Ω



Common Emitter S-Parameters

V _{CE} /V	I _C /mA	f/MHz	S11		S21		S12		S22	
			LIN MAG	ANG	LIN MAG	ANG	LIN MAG	ANG	LIN MAG	ANG
				deg		deg		deg		deg
2	0.5	100	9.976	-3.8	1.71	174.9	0.015	86.8	0.998	-2.3
		200	0.969	-7.9	1.71	168.9	0.029	83.4	0.993	-4.7
		300	0.955	-11.7	1.70	163.3	0.044	80.0	0.984	-6.7
		400	0.939	-15.5	1.68	157.7	0.058	76.8	0.974	-8.7
		500	0.920	-18.9	1.64	151.9	0.070	73.6	0.959	-10.6
		600	0.901	-22.4	1.62	147.2	0.082	71.5	0.948	-12.4
		700	0.881	-25.8	1.58	142.2	0.093	69.0	0.935	-13.9
		800	0.861	-28.9	1.56	137.6	0.104	66.7	0.922	-15.5
		900	0.838	-32.3	1.53	133.1	0.114	65.0	0.909	-17.2
		1000	0.818	-35.4	1.50	129.4	0.121	63.5	0.898	-18.6
		1100	0.793	-38.8	1.49	125.1	0.130	61.8	0.884	-19.7
		1200	0.772	-41.5	1.46	121.3	0.138	60.4	0.873	-21.3
		1300	0.746	-45.1	1.44	117.2	0.148	58.6	0.859	-22.6
2	1.5	100	0.972	-7.5	4.84	170.9	0.016	84.8	0.990	-3.9
		200	0.898	-14.5	4.69	161.7	0.031	79.8	0.972	-7.4
		300	0.858	-21.0	4.49	153.1	0.045	75.1	0.944	-10.6
		400	0.811	-27.0	4.27	145.1	0.057	71.5	0.913	-13.1
		500	0.762	-32.2	4.01	137.8	0.067	68.3	0.880	-15.3
		600	0.710	-36.8	3.77	131.3	0.077	65.9	0.849	-16.8
		700	0.662	-40.3	3.55	125.3	0.085	63.6	0.820	-17.8
		800	0.617	-43.8	3.33	120.0	0.093	62.1	0.796	-18.7
		900	0.576	-46.9	3.15	115.1	0.099	61.2	0.775	-19.5
		1000	0.540	-50.0	2.98	110.7	0.106	60.3	0.756	-20.3
		1100	0.502	-52.4	2.82	106.5	0.113	59.5	0.740	-20.8
		1200	0.470	-54.8	2.69	102.8	0.118	59.3	0.724	-21.4
		1300	0.439	-57.6	2.56	99.0	0.123	58.7	0.710	-21.7

Typical Characteristics (T_{amb} = 25 °C unless otherwise specified)

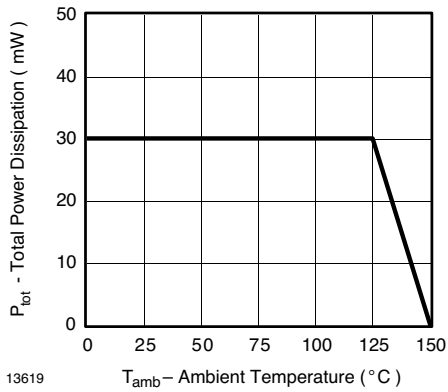


Figure 1. Total Power Dissipation vs. Ambient Temperature

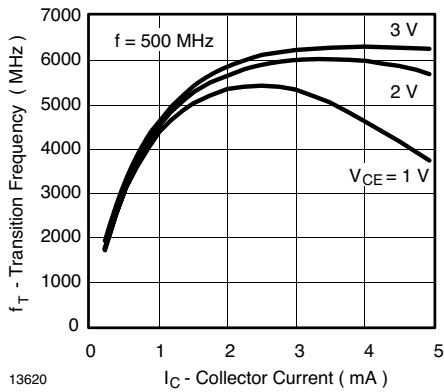


Figure 2. Transition Frequency vs. Collector Current

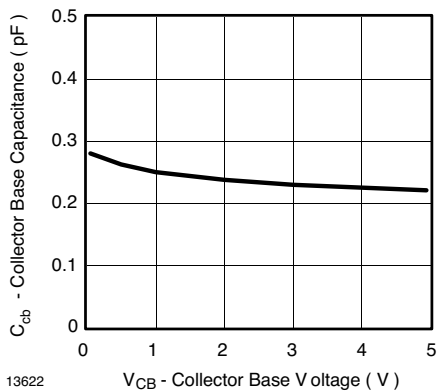


Figure 3. Collector Base Capacitance vs. Collector Base Voltage

$V_{CE} = 8\text{ V}$, $I_C = 25\text{ mA}$, $Z_0 = 50\ \Omega$

S_{11}

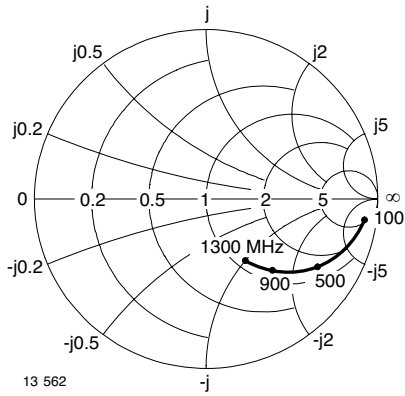


Figure 4. Input Reflection Coefficient

S_{12}

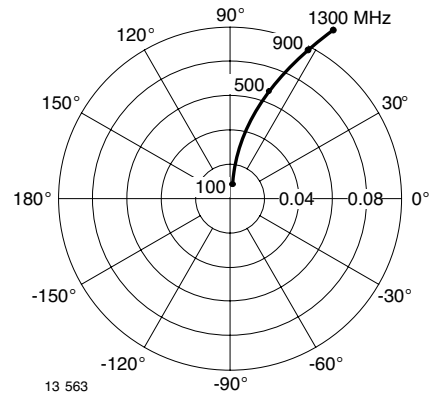


Figure 6. Reverse Transmission Coefficient

S_{21}

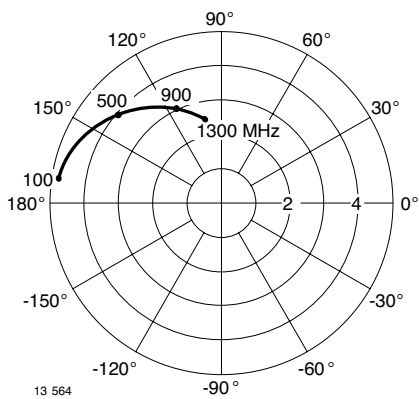


Figure 5. Forward Transmission Coefficient

S_{22}

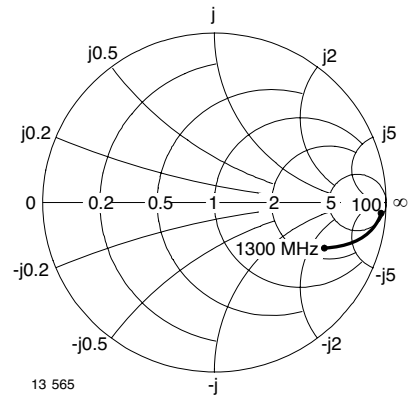


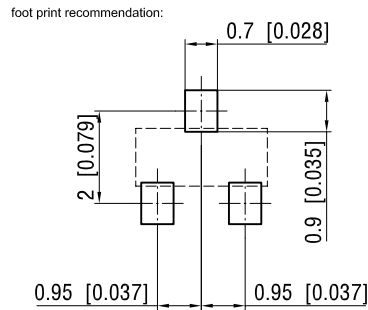
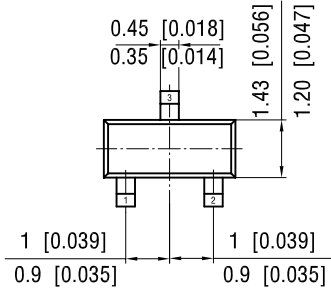
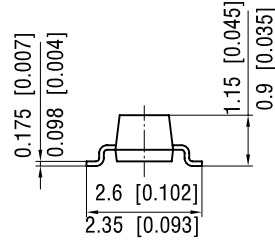
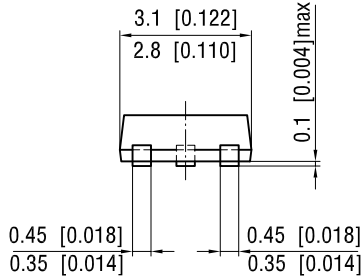
Figure 7. Output Reflection Coefficient

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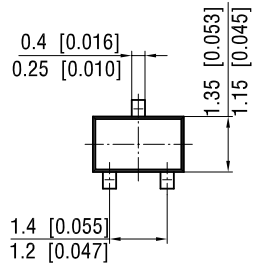
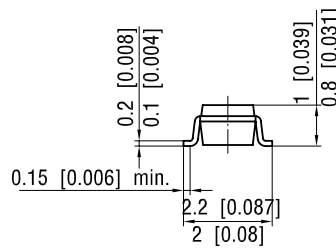
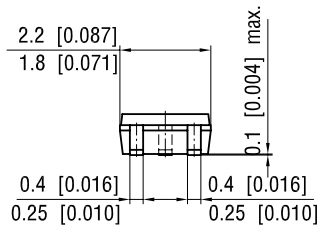


Package Dimensions in mm (Inches)

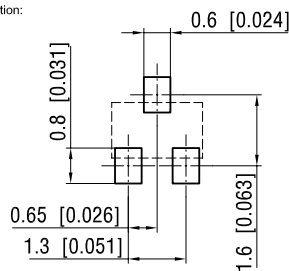


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Rev. 7 - Date: 08.July.2004
17418

Package Dimensions in mm (Inches)



foot print recommendation:



Rev. 4 - Date: 26.January.2005
Document no.:6.541-5040.01-4
96 12236



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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